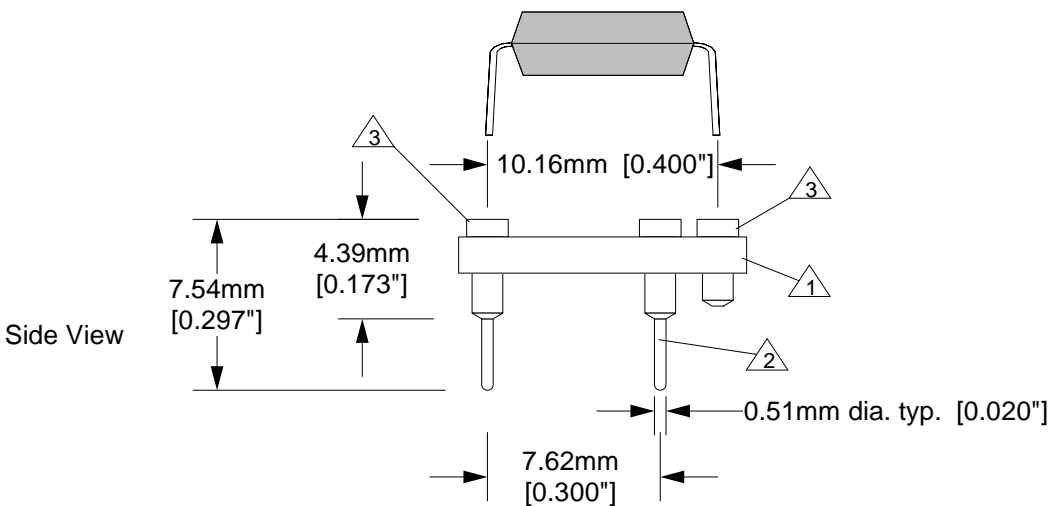
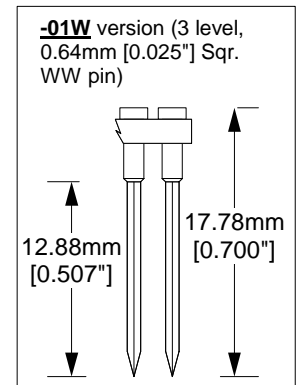


Top View



Side View




- ① Substrate: 1.59mm \pm 0.18mm [0.0625" \pm 0.007"] FR4/G10 or equivalent high temp material. 17 μ m [1/2 oz.] Cu clad. Lead Free HASL (RoHS) SMOBC plating.
- ② Pins: material- Brass Alloy 360 1/2 hard; finish- 0.25 μ m [10 μ] Au over 1.27 μ m [50 μ] Ni (min.).
- ③ Pins: shell material- Brass Alloy 360 1/2 hard; finish- 0.25 μ m [10 μ] Au over 1.27 μ m [50 μ] Ni (min.). Contact material- BeCu; finish 0.25 μ m [10 μ] Au over 2.54 μ m [100 μ] Ni (min.).

Description: Package Converter

22 position 10.16mm [0.400"] female DIP to 7.62mm [0.300"] male DIP adaptor.

Add "W" to end of part number for wire wrap version.

Tolerances: diameters \pm 0.03mm [\pm 0.001"], PCB perimeters \pm 0.13mm [\pm 0.005"], PCB thicknesses \pm 0.18mm [\pm 0.007"], pitches (from true position) \pm 0.08mm [\pm 0.003"], all other tolerances \pm 0.13mm [\pm 0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

PC-DIP/DIP22-01 Drawing		Status: Released	Scale 3:1	Rev: E
 <p>© 2000 IRONWOOD ELECTRONICS, INC. Tele: (800) 404-0204 www.ironwoodelectronics.com</p>	Drawing: P. Jasmin		Date: 6/17/93	
	File: PC-DIP/DIP22-01 Dwg		Modified: 9/5/13	